

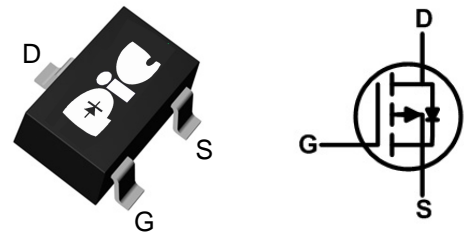
➤ General Description

This PAP0037ANS P-Channel enhancement mode power field effect transistor is the high density trench technology and this advanced technology can provide excellent $R_{ds(On)}$ performance and efficiency for power switching and load switching application., this device also comply with the RoHS and Green Product requirement with full function reliability approved.

➤ Feature

- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- SOT-23S package design

➤ SOT-23S



➤ Application

- Direct Logic-Level Interface: TTL/CMOS
- Drivers: Relays, Solenoids, Lamps, Hammers
- Battery Operated Systems, DC/DC Converters
- Solid-State Relays
- Load/Power Switching-Cell Phones, Pagers

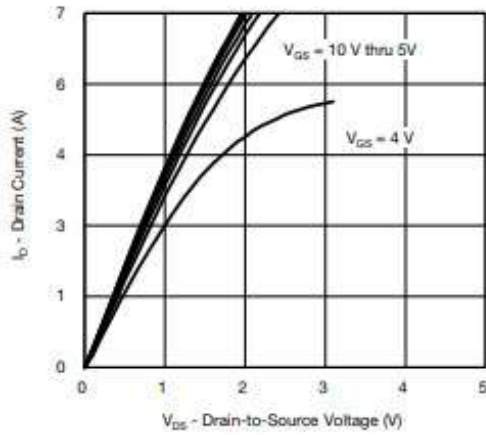
➤ Absolute Maximum Ratings

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V_{DSS}	-100	V
Gate –Source Voltage	V_{GSS}	± 20	V
Continuous Drain Current($T_J=150^\circ C$)	I_D	$T_A=25^\circ C$	-3.8
		$T_A=70^\circ C$	-2.6
Pulsed Drain Current	I_{DM}	-10	A
Continuous Source Current(Diode Conduction)	I_S	-4.0	A
Power Dissipation	P_D	$T_A=25^\circ C$	2.8
		$T_A=70^\circ C$	1.2
Operating Junction Temperature	T_J	150	$^\circ C$
Storage Temperature Range	T_{STG}	-55/150	$^\circ C$
Thermal Resistance-Junction to Ambient	$R_{\theta JA}$	120	$^\circ C/W$

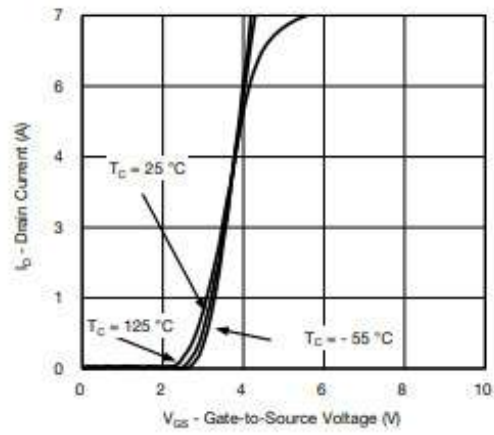
➤ **Electrical Characteristics ($T_A=25^\circ C$ Unless otherwise noted)**

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=-250\mu A$	-100			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1.0	-1.78	-2.5	
Gate Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 20V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-80V, V_{GS}=0V$			-1	uA
		$V_{DS}=-80V, V_{GS}=0V$ $T_J=85^\circ C$			-30	
On-State Drain Current	$I_{D(on)}$	$V_{DS}\geq -10V, V_{GS}=-10V$	-8			A
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=-10V, I_D=-3.8A$		270	295	m Ω
		$V_{GS}=-4.5V, I_D=-2.6A$		300	325	
Forward Transconductance	g_{FS}	$V_{DS}=-15V, I_D=-3.2A$		12		S
Diode Forward Voltage	V_{SD}	$I_S=-2A, V_{GS}=0V$		-0.8	-1.3	V
Dynamic						
Total Gate Charge	Q_g	$V_{DS}=-40V, V_{GS}=-4.5V$ $I_D=-1.2A$		12	20	Nc
Gate-Source Charge	Q_{gs}		2.0			
Gate-Drain Charge	Q_{gd}		3.5			
Input Capacitance	C_{iss}	$V_{DS}=-40V, V_{GS}=0V$ $f=1MHz$		520	650	pF
Output Capacitance	C_{oss}		45	60		
Reverse Transfer Capacitance	C_{rss}		30	45		
Turn-On Time	$t_{d(on)}$	$V_{DD}=-40V, R_L=42\Omega$ $I_D\equiv -1.0A, V_{GEN}=-10V$ $R_G=1\Omega$		7	15	ns
	t_r			10	20	
Turn-Off Time	$t_{d(off)}$			20	40	
	t_f			7	15	

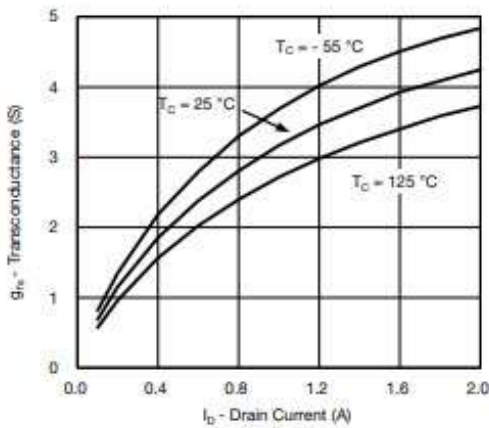
➤ Typical Characteristics



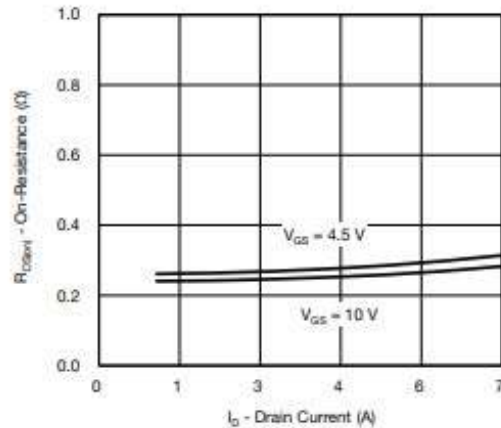
Output Characteristics



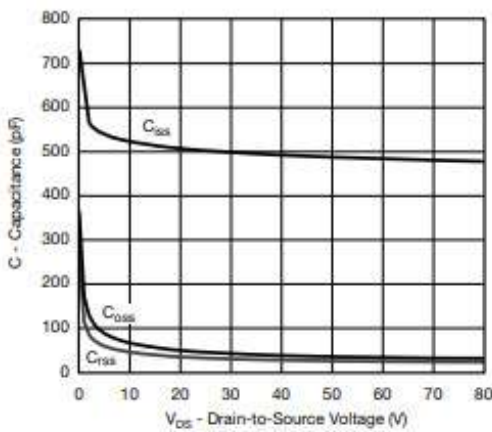
Transfer Characteristics



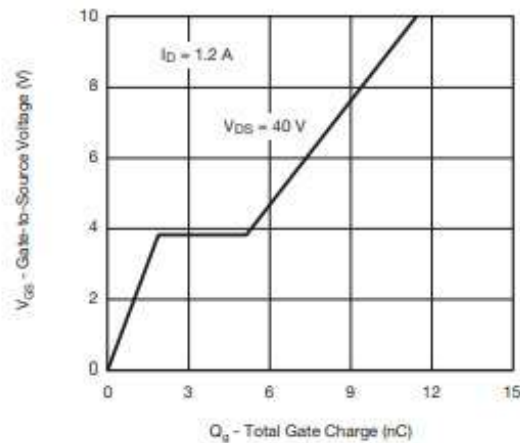
Transconductance



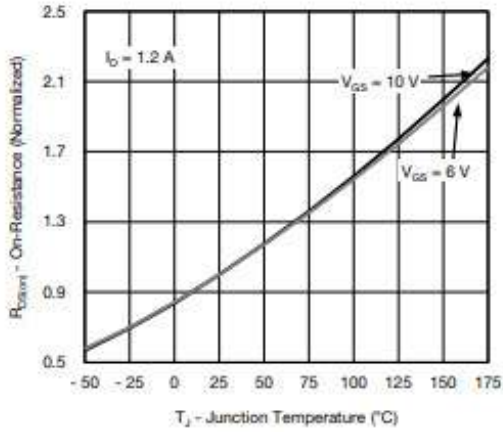
On-Resistance vs. Drain Current



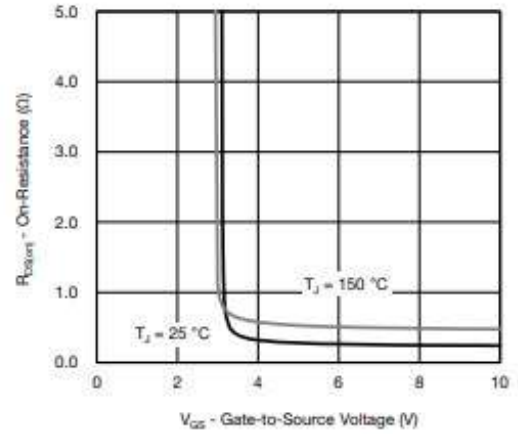
Capacitance



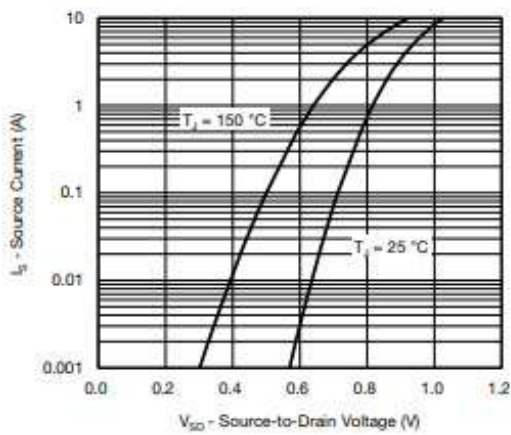
Gate Charge



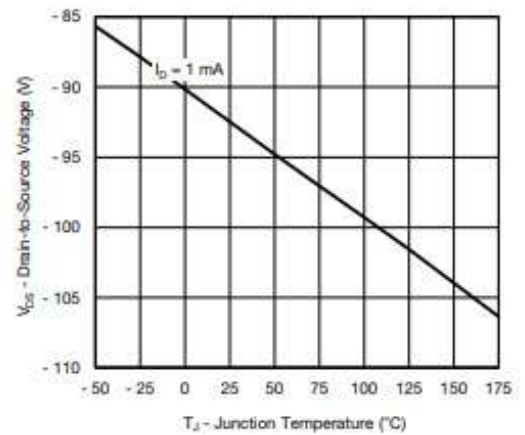
On-Resistance vs. Junction Temperature



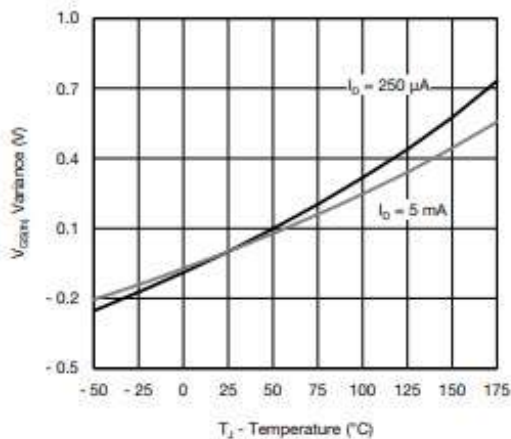
On-Resistance vs. Gate-to-Source Voltage



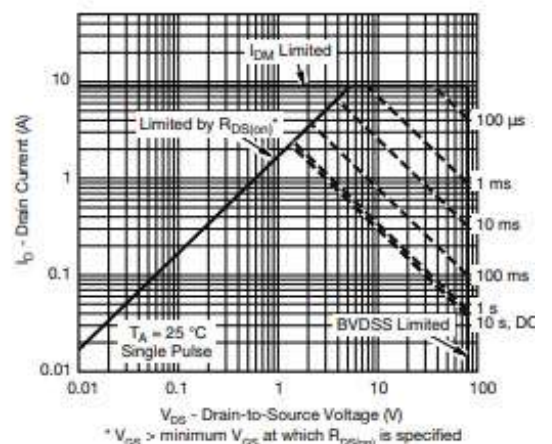
Source-Drain Diode Forward Voltage



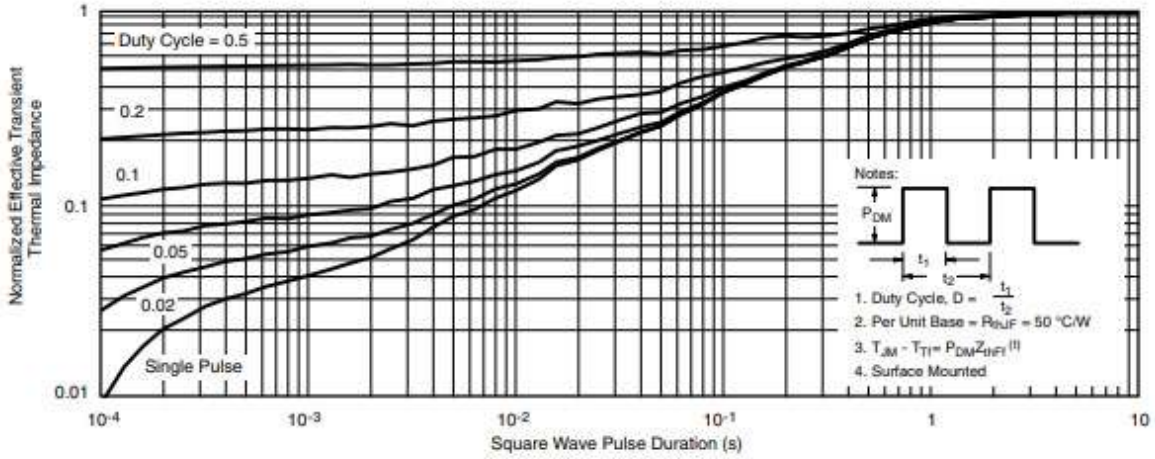
Drain Source Breakdown vs. Junction Temperature



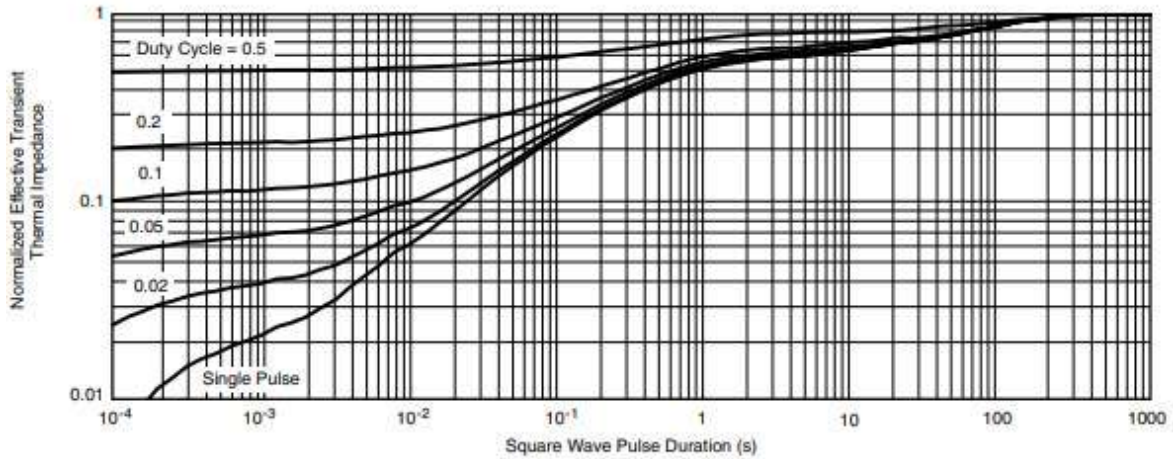
Threshold Voltage



Safe Operating Area

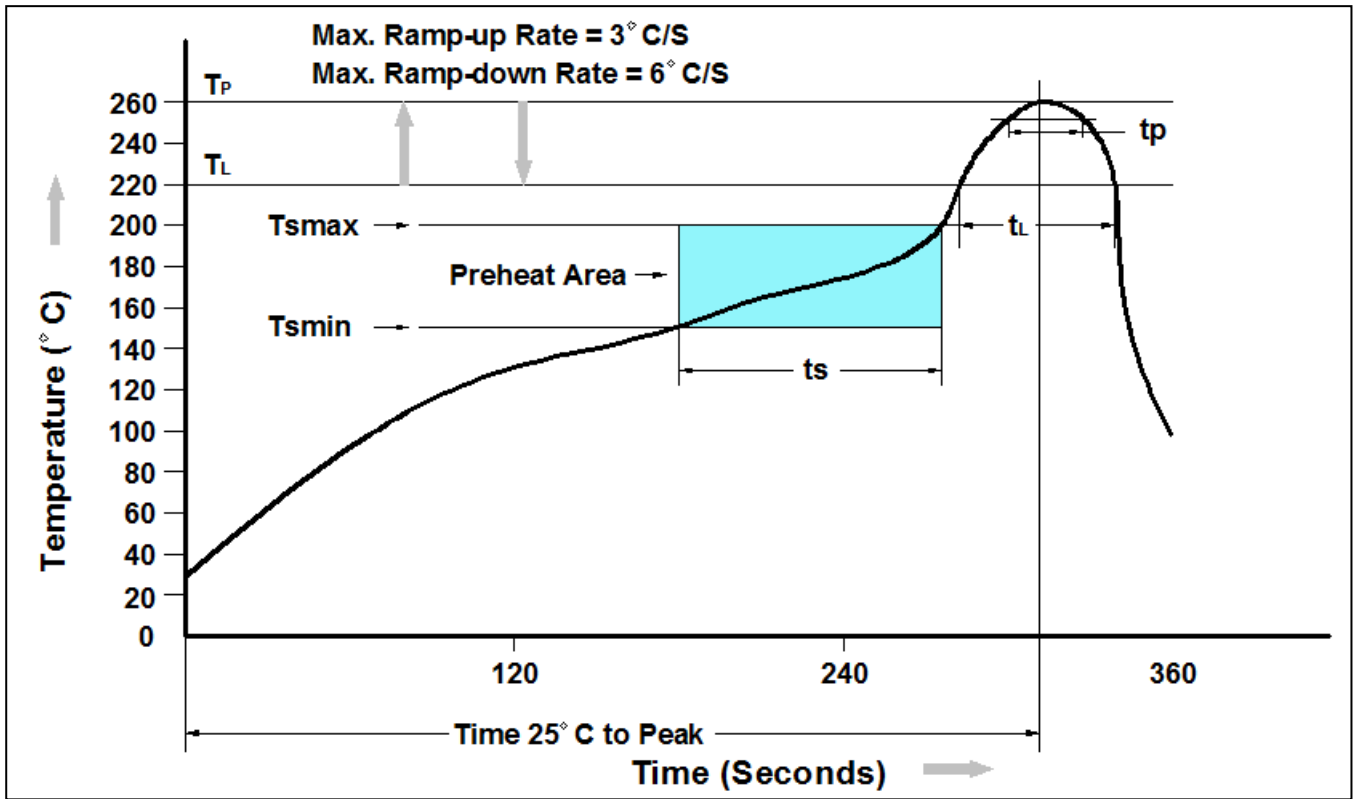


Normalized Thermal Transient Impedance, Junction-to-Foot



Normalized Thermal Transient Impedance, Junction-to-Ambient

➤ Recommand IR Reflow Soldering Thermal Profile

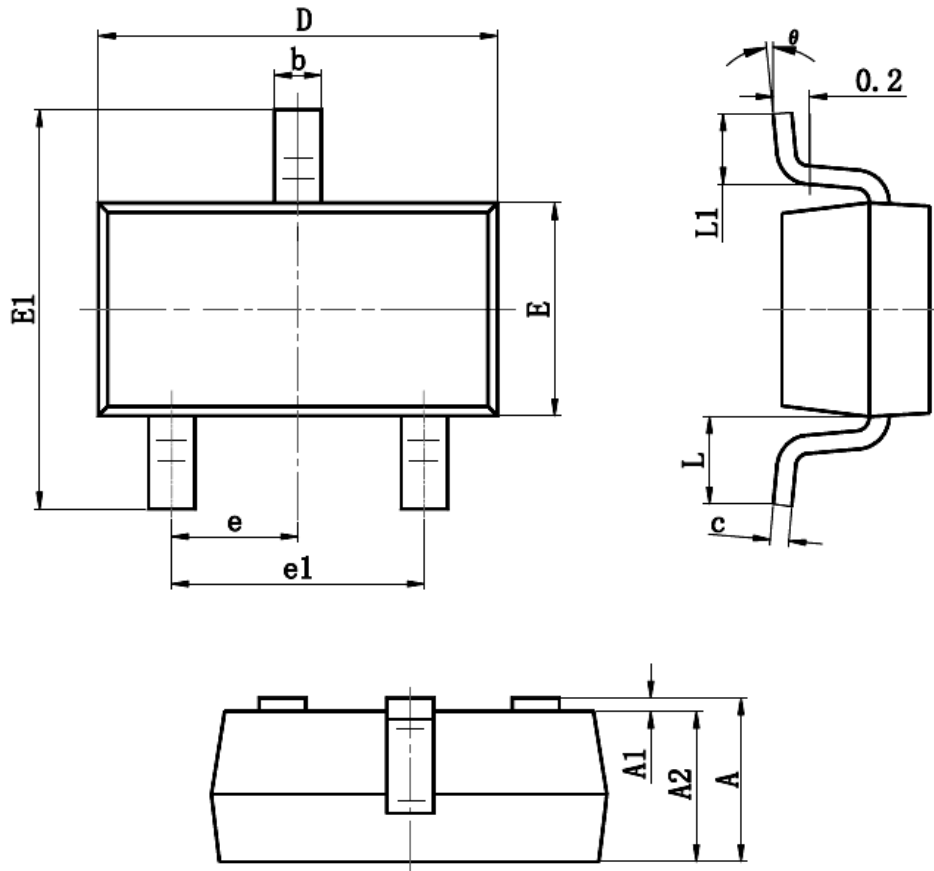


Profile Feature	Pb-Free Assembly Profile
Temperature Min. (T _{smin})	150°C
Temperature Max. (T _{smax})	200°C
Time (t _s) from (T _{smin} to T _{smax})	60-120 seconds
Average Ramp-up Rate (t _L to t _P)	3°C/second max.
Liquidous Temperature (T _L)	217°C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds
Peak Temperature	260°C +0°C / -5°C
Time (t _P) within 5°C of actual Peak Temperature	30 seconds
Ramp-down Rate (T _P to T _L)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.

➤ Ordering Information

Part Number	Description	Quantity
PAP0037ANS	SOT-23S Reel	3000 pcs

➤ Package Information (SOT-23S)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.200	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.100	0.035	0.039
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	6°

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